

**EXPEDITED PROCEDURE – EXAMINING GROUP 2822**

**S/N 10/812,277**

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant:	Iwen Chao et al.	Examiner:	Monica Lewis
Serial No.:	10/812,277	Group Art Unit:	2822
Filed:	March 29, 2004	Docket No.:	884.C26US1
Title:	SEMICONDUCTING DEVICE WITH FOLDED INTERPOSER		
Assignee:	Intel Corporation	Customer Number:	21186

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**SUPPLEMENTAL AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

This paper is in response to the Advisory Action mailed April 20, 2006 and is supplemental to the Amendment and Response Under 37 CFR 1.116 filed March 21, 2006 in response to the Final Office Action mailed February 28, 2006. Please amend the application as follows: